

PACKAGE DIMENSIONS 0.200 (5.08) 0.180 (4.57) 0.350 (8.89) 0.040 (1.02) 0.330 (8.38) 1.00 (25.4) MIN 0.050 (1.27) 0.050 (1.27) REF. 0.100 (2.54) -0.100 (2.54) Ø 0.230 (5.84) **FLAT DENOTES** 0.023 (0.58) 0.017 (0.43) SQ. TYP. (2X) CATHODE

SUPER GREEN MV8R0X MV8R01 MV8R03

FEATURES

- Popular T-1 3/4 package
- Super high brightness suitable for outdoor applications
- Solid state reliability
- Water clear optics
- Standard 100 mil. lead spacing



NOTES:

- 1. Dimensions for all drawings are in inches (mm).
- 2. Lead spacing is measured where the leads emerge from the package.
- 3. Protruded resin under the flange is 1.5 mm (0.059") max.

DESCRIPTION

This T-1 3/4 super bright LED has a moderate viewing angle of 20° for concentrated light output. It is made with an InGaN LED that emits green light at 520 nm. It is encapsulated in a water clear epoxy lens package.

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise specified)				
Parameter	Symbol	Rating	Unit	
Operating Temperature	T _{OPR}	-20 to +80	°C	
Storage Temperature	T _{STG}	-30 to +100	°C	
Lead Soldering Time	T _{SOL}	260 for 5 sec	°C	
Continuous Forward Current	I _F	30	mA	
Peak Forward Current		100	mA	
(f = 1.0 KHz, Duty Factor = 1/10)	l _F			
Reverse Voltage	V _R	5	V	
Power Dissipation	P _D	120	mW	



SUPER GREEN	MV8R0X
MV8R01	
MV8R03	

Part Number	MV8R01	MV8R03	Condition
Luminous Intensity (mcd)			I _F = 20 mA
Minimum	1500	3000	
Typical	1900	3500	
Forward Voltage (V)			I _F = 20 mA
Maximum	4.2	4.2	
Typical	3.6	3.6	
Wavelength (nm)			I _F = 20 mA
Peak	5	20	
Dominant	5	25	
Spectral Line Half Width (nm)	4	10	I _F = 20 mA
Viewing Angle (°)	2	20	I _F = 20 mA

TYPICAL PERFORMANCE CURVES

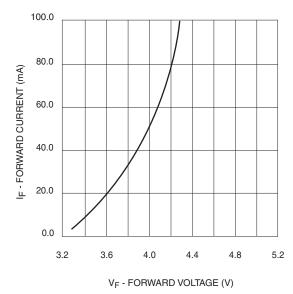


Fig. 1 Forward Current vs. Forward Voltage

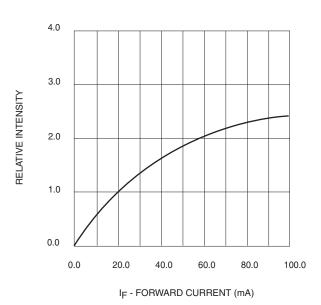


Fig. 2 Relative Luminous Intensity vs.
Forward Current



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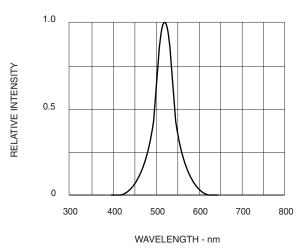
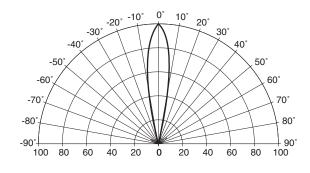


Fig. 3 Relative Luminous Intensity vs. Wavelength



REL. LUMINOUS INTENSITY (%)

Fig. 4 Radiation Diagram



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